DISA LIMITED
(Company Registration Number: 197501110N)
(Incorporated in the Republic of Singapore)

TERMINATION OF LETTER OF APPOINTMENT AND PROPOSED PLACEMENT OF CONVERTIBLE BONDS

1. INTRODUCTION

The Board of Directors ("**Board**" or "**Directors**") of DISA Limited (the "**Company**", and together with its subsidiaries, the "**Group**") refers to its announcement dated 6 July 2026 ("**Announcement**") in relation to the Company's entry into a letter of appointment with UOB Kay Hian Private Limited ("**Placement Agent**") to procure subscribers for the subscription of unlisted and transferable convertible bonds in the aggregate principal amount of up to S$5,000,000 by way of placement ("**Proposed Placement**"). Unless otherwise defined, all capitalised terms used herein shall bear the same meanings ascribed to them in the Announcement.

2. TERMINATION OF LETTER OF APPOINTMENT AND PROPOSED PLACEMENT OF CONVERTIBLE BONDS

The Board wishes to announce that the Letter of Appointment has been terminated by mutual agreement of the parties with effect from 27 July 2026, following further discussions on the terms of the definitive documentation and having regard to prevailing market conditions. Accordingly, the respective obligations and liabilities of the parties under the Letter of Appointment shall cease and the parties shall have no further claims against each other thereunder.

Following the termination of the Letter of Appointment, the Company will not be proceeding with the Proposed Placement.

The Company will continue to explore other potential strategic opportunities and/or alternative modes of capital fund-raising with a view to increasing the financial resources available to the Group, to support the operating expenditure and working capital requirements of the Subsidiary, and allow the Group to further strengthen its financial position and capital base.

BY ORDER OF THE BOARD

Chng Weng Wah
Executive Chairman, Managing Director and Chief Executive Officer
27 July 2026

*This announcement has been reviewed by the Company's sponsor, SAC Capital Private Limited (the "**Sponsor**"). This announcement has not been examined or approved by the Singapore Exchange Securities Trading Limited (the "**SGX-ST**") and the SGX-ST assumes no responsibility for the contents of this announcement including the correctness of any of the statements or opinions made or reports contained in this announcement.*

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